IN THE CLAIMS

Please amend the claims as follows.

1. (Currently Amended) A surface-heating system comprising:

an active reflect-array antenna system to provide a collimated high-power wavefront at a millimeter-wave frequency in a direction of a surface to heat the surface within a surface depth by amplifying and reflecting a spatially-fed millimeter-wave lower-power wavefront; and

a low-power feed to provide the spatially-fed millimeter-wave lower-power wavefront for incident on the active reflect-array.

wherein the active reflect-array antenna system comprises a plurality of individual semiconductor wafers arranged together on a surface, each wafer configured to receive, amplify and retransmit.

2. (Currently Amended) A surface-heating system comprising:

an active reflect-array antenna system to provide a collimated high-power wavefront at a millimeter-wave frequency in a direction of a surface to heat the surface within a surface depth by amplifying and reflecting a spatially-fed millimeter-wave lower-power wavefront; and

a low-power feed to provide the spatially-fed millimeter-wave lower-power wavefront for incident on the active reflect-array,

The system of claim 1-wherein the active reflect-array antenna system comprises a plurality of individual semiconductor wafers arranged together on a surface, wherein each semiconductor wafer comprises:

a receive antenna to receive signals of the spatially-fed millimeter-wave lower-power wavefront;

a set of power amplifiers coupled to the receive antenna to amplify the received signals; and

a transmit antennas to transmit amplified millimeter-wave signals,

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wherein the amplified millimeter-wave signals transmitted by the transmit antennas of each semiconductor wafer spatially combine to generate the collimated high-power wavefront.

- 3. (Canceled)
- (Previously Presented) The system of claim 2 wherein the plurality of semiconductor wafers is arranged in a substantially parabolic shape.
 - 5. (Canceled)
- (Previously Presented) The system of claim 2 further comprising a frequency generator
 to generate the millimeter-wave frequency and provide the millimeter-wave frequency to the
 low-power feed,

wherein the frequency generator and the active reflect-array antenna system are part of a wavefront-generating subsystem, the system further comprising a thermal-sensing subsystem to measure a surface temperature and generate a control signal for the wavefront-generating subsystem to control the surface temperature.

- 7. (Previously Presented) The system of claim 6 wherein the active reflect-array antenna system generates a continuous-wave wavefront, and wherein the antenna system changes a transmit power level of the wavefront in response to the control signal from the thermal-sensing subsystem to control the surface temperature.
- 8. (Previously Presented) The system of claim 6 wherein the active reflect-array antenna system generates a pulsed high-power wavefront, and wherein the antenna system reduces one of either a pulse-repetition-rate or a pulse-duration time of the high-power wavefront in response to the control signal to control the surface temperature.
- (Previously Presented) The system of claim 2 further comprising a housing having a cavity for placement of a food item, and

wherein the active reflect-array antenna system is one of a plurality of active reflectarray antenna systems positioned within the cavity to direct a plurality of high-power millimeterwave wavefronts within the cavity to heat a surface of the food item.

- 10. (Original) The system of claim 9 further comprising a microwave amplifier and associated antenna to direct microwave energy within the cavity to heat the food item below the surface.
 - 11. (Currently Amended) A surface-heating system comprising:

an active reflect-array antenna system to provide a collimated high-power wavefront at a millimeter-wave frequency in a direction of a surface to heat the surface within a surface depth by amplifying and reflecting a spatially-fed millimeter-wave lower-power wavefront; and

a low-power feed to provide the spatially-fed millimeter-wave lower-power wavefront for incident on the active reflect-array,

The system of claim 1-wherein the active reflect-array antenna system is a first active reflect-array antenna system and the low-power feed is a second active reflect-array antenna system.

wherein the low-power feed amplifies and reflects millimeter-wave signals received from a source located within of the first active reflect-array antenna system, the low-power feed comprising:

one or more receive antennas to receive the millimeter-wave signals from the source; one or more amplifiers to amplify the received millimeter-wave frequency signals; and one or more transmit antennas to transmit the amplified millimeter-wave signals and generate the lower-power wavefront for incidence on the first active reflect-array antenna system.

12. (Previously Presented) The system of claim 2 wherein the low-power feed comprises a passive reflector to reflect a millimeter-wave frequency signal from a feed and provide the lower-power wavefront for incident on the active reflect-array antenna system.

- 13. (Original) The system of claim 2 wherein the plurality of semiconductor wafers is arranged on a substantially flat surface.
 - 14. (Previously Presented) The system of claim 2 further comprising
- a low-voltage, high-current power supply to generate current for the active reflect-array antenna system and a frequency generator; and
- a cooling subsystem to cool the active reflect-array antenna system and the power supply, wherein the cooling system comprises one of either a thermo-electric-cooling (TEC) element, a phase change fluid, or coolant.
 - 15. (Withdrawn) A millimeter-wave surface-heating system comprising:
 - a reflector to reflect a high-power millimeter-wave signal; and
- a passive reflect-array antenna to receive the reflected high-power millimeter-wave signal and re-transmit the signal to provide a collimated high-power wavefront,

wherein the passive reflect-array antenna comprises a plurality of dual-polarized dipoles of varying sizes arranged circumferentially in a substantially flat surface to operate as a parabolic surface to provide the collimated high-power wavefront at a millimeter-wave frequency in a direction of a surface to heat the surface, and

wherein the reflector provides a spatially-fed millimeter-wave wavefront for incidence on the passive reflect-array antenna.

- 16. (Withdrawn) The system of claim 15 further comprising a high-power amplifier to generate the high-power millimeter-wave frequency signal.
- 17. (Previously Presented) The system of claim 6 wherein the frequency generator is configured to generate a plurality of differing millimeter-wave frequencies,

wherein the active reflect-array antenna system provides the high-power wavefront comprising the differing millimeter-wave frequencies, and

wherein the system further comprises a system controller to control a frequency and power level of the wavefront to selectively heat layers of the surface. Title: SELECTIVE LAYER MILLIMETER-WAVE SURFACE-HEATING SYSTEM AND METHOD

- 18. (Previously Presented) The system of claim 17 wherein the high-power wavefront is time-multiplexed with differing millimeter-wave frequencies.
 - 19. (Canceled)
 - 20. (Withdrawn) A system for browning food comprising:
 - a housing having a cavity; and
- a plurality of active-arrays within the cavity to direct a plurality of high-power millimeter-wave wavefronts within the cavity to heat a surface of a food item placed therein,

wherein the wavefronts are either collimated or converging high-power wavefronts at a millimeter-wave frequency.

21. (Withdrawn) The system of claim 20 wherein active arrays have a plurality of semiconductor wafers arranged on a substantially flat surface, wherein each semiconductor wafer comprises:

one or more sets of power amplifiers to amplify a millimeter-wave frequency signal; and one or more transmit antennas to generate either the collimated or converging high-power wavefronts.

wherein each set of power amplifiers is associated with one of the transmit antennas.

- 22. (Withdrawn) The system of claim 20 further comprising:
- a thermal-sensing subsystem to measure a surface temperature of the food item and generate a control signal to maintain the surface temperature substantially within a predetermined temperature range; and
- a microwave amplifier and associated antenna to direct microwave energy within the cavity to heat the food item below the surface.

- 23. (Withdrawn) The system of claim 22 wherein the active arrays generate a continuouswave wavefront, and wherein a transmit power level of the wavefront is changed in response to the control signal from the thermal-sensing subsystem to control the surface temperature.
- 24. (Withdrawn) The system of claim 22 wherein the active arrays generate a pulsed high-power wavefront, and wherein one of either a pulse-repetition-rate or a pulse-duration time of the high-power wavefront is changed in response to the control signal to control the surface temperature.
- 25. (Withdrawn) The system of claim 20 further comprising a frequency generator to generate a plurality of differing millimeter-wave frequencies, and wherein the active arrays provide the high-power wavefronts comprising the differing millimeter-wave frequencies, and wherein the system further comprises a system controller to control a frequency and power level of the wavefronts to selectively heat layers of the surface.
- 26. (Withdrawn) The system of claim 25 wherein the high-power wavefronts comprising the differing millimeter-wave frequencies are time-multiplexed with the differing millimeterwave frequencies.
- 27. (Withdrawn) A system for removing paint on a surface comprising: a frequency generator to generate a millimeter-wave frequency; and an antenna system to provide either a collimated or converging high-power wavefront at the millimeter-wave frequency in a direction of a surface to heat the surface to within a surface

wherein the antenna system comprises an active array having a plurality of semiconductor wafers arranged on a surface, wherein each semiconductor wafer comprises: one or more sets of power amplifiers to amplify the millimeter-wave frequency; and one or more transmit antennas to generate either the collimated or converging high-power wavefront.

depth,

wherein each set of power amplifiers is associated with one of the transmit antennas.

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28. (Withdrawn) The system of claim 27 wherein the active array is an active reflect-array to receive a spatially fed millimeter-wave lower-power wavefront, amplify the lower-power wavefront, and generate the high-power wavefront, and

wherein the plurality of semiconductor wafers is arranged in a substantially parabolic shape, and wherein each semiconductor wafer includes:

one or more receive antennas to receive the spatially fed millimeter-wave lower-power wavefront;

one or more sets of power amplifiers to amplify signals of the spatially fed millimeterwave lower-power wavefront; and

one or more transmit antennas to transmit the amplified signals to generate either the collimated or converging high-power wavefront,

wherein each set of power amplifiers is associated with one of the transmit and one of the receive antennas.

- 29. (Withdrawn) The system of claim 28 further comprising a thermal-sensing subsystem to measure a surface temperature and generate a control signal for the wavefront-generating subsystem to control the surface temperature.
- 30. (Withdrawn) The system of claim 29 wherein the antenna system generates a continuous-wave wavefront, and wherein the antenna system changes a transmit power level of the wavefront in response to the control signal from the thermal-sensing subsystem to control the surface temperature.
- 31. (Withdrawn) The system of claim 29 wherein the antenna system generates a pulsed high-power wavefront, and wherein the antenna system reduces one of either a pulse-repetition-rate or a pulse-duration time of the high-power wavefront in response to the control signal to control the surface temperature.

- 32. (Withdrawn) A method of heating a surface comprising generating either a collimated or converging high-power wavefront at the millimeter-wave frequency in a direction of a surface using a semiconductor-based active array antenna.
 - 33. (Withdrawn) The method of claim 32 further comprising:

measuring a surface temperature and generating a control signal to control the surface temperature; and

changing either a transmit power level of the wavefront, a pulse-repetition-rate of the wavefront, or a pulse-duration time of the wavefront in response to the control signal from the thermal-sensing subsystem to control the surface temperature.

34. (Withdrawn) The method of claim 33 wherein generating comprises:

receiving a spatially-fed lower-power millimeter-wave wavefront incident on an active reflect array comprising a plurality of semiconductor wafers arranged on a surface having receive antennas thereon:

amplifying signals of the received lower-power wavefront with power amplifiers on the wafers; and

retransmitting the signals of the received wavefront to generate the high-power wavefront in the direction of the surface with transmit antennas on the wafers.

35. (Withdrawn) The method of claim 32 wherein generating comprises generating a plurality of differing millimeter-wave frequencies to provide the high-power wavefront comprising the differing millimeter-wave frequencies, and

wherein the method further comprises controlling a frequency and power level of the wavefront to selectively heat layers of the surface.

36. (Withdrawn) The method of claim 35 further comprising time-multiplexing the differing millimeter-wave frequencies of the high-power wavefront to selectively heat layers of the surface. Title: SELECTIVE LAYER MILLIMETER-WAVE SURFACE-HEATING SYSTEM AND METHOD

37. (Withdrawn) The method of claim 32 wherein generating comprises generating either the collimated high-power wavefront, the converting high-power wavefront, or a diverging highpower wavefront.